

75332S-VB Datasheet N-Channel 60-V (D-S) MOSFET

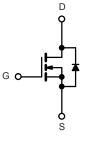
PRODUCT SUMMARY			
V _{DS}	60	V	
$R_{DS(on)}$ $V_{GS} = 10$ V	11	mΩ	
$R_{DS(on)}$ $V_{GS} = 4.5$ V	12	mΩ	
I _D	75	А	
Configuration	Single		

FEATURES

- 175 °C Junction Temperature
- Trench Power MOSFET







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_c = 2$	25 °C, unless othe	rwise noted)		
Parameter	Symbol	Limit	Unit	
Gate-Source Voltage		V _{GS}	± 20	V
	T _C = 25 °C		75	
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 100 °C		50 ^a	
Pulsed Drain Current	I _{DM}	200	А	
Continuous Source Current (Diode Conduction)	۱ _S	50 ^a		
Avalanche Current	I _{AS}	50		
Single Avalanche Energy (Duty Cycle \leq 1 %)	L = 0.1 mH	E _{AS}	125	mJ
Maximum Davies Dissignation	T _C = 25 °C	Р	136	w
Maximum Power Dissipation	T _A = 25 °C	• P _D —	3 ^b , 8.3 ^{b, c}	vv
Operating Junction and Storage Temperature Range	·	T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum lumation to Ambianta	$t \le 10 \text{ sec}$	R _{thJA}	15	18	°C/W		
Maximum Junction-to-Ambient ^a	Steady State	⊡ ThJA	40	50			
Maximum Junction-to-Case	·	R _{thJC}	0.85	1.1			
Notes:							

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t \leq 10 s.



Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 µA	60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1		3	V	
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			± 100	nA	
		V_{DS} = 60 V, V_{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 125 °C		50			
		V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	60			А	
		V _{GS} = 10 V, I _D = 20 A		0.011		-Ω	
Drain-Source On-State Resistance ^b		V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.016			
	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.020			
		V _{GS} = 4.5 V, I _D = 15 A		0.012			
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		60		S	
Dynamic							
Input Capacitance	C _{iss}			4300			
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		470		pF	
Reverse Transfer Capacitance	C _{rss}			225			
Total Gate Charge ^c	Qg			47		nC	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 30 V, V_{GS} = 10 V, I_D = 50 A		10			
Gate-Drain Charge ^c	Q _{gd}			12		1	
Turn-On Delay Time ^c	t _{d(on)}			10	20		
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.6 Ω		15	25		
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_{D} \cong$ 50 A, V_{GEN} = 10 V, Rg = 2.5 Ω		35	50	ns	
Fall Time ^c	t _f			20	30		
Source-Drain Diode Ratings and Cha	racteristics (T _C = 25 °C)	•	·			
Pulsed Current	I _{SM}				60	А	
Diode Forward Voltage	V _{SD}	I _F = 20 A, V _{GS} = 0 V		1	1.5	V	
Reverse Recovery Time	t _{rr}	I _F = 20 A, di/dt = 100 A/μs		45	100	ns	

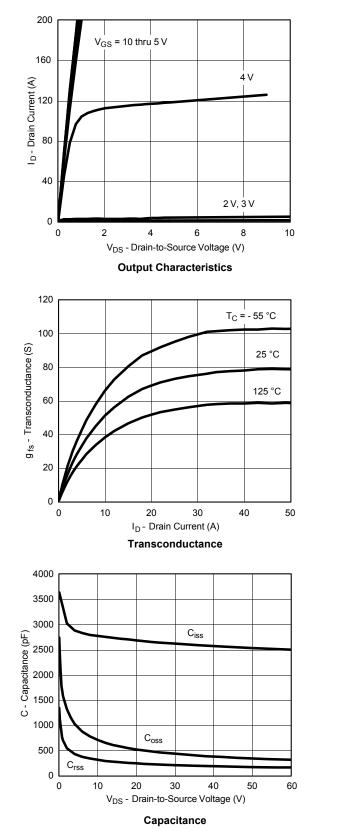
Notes:

a. For design aid only; not subject to production testing. b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

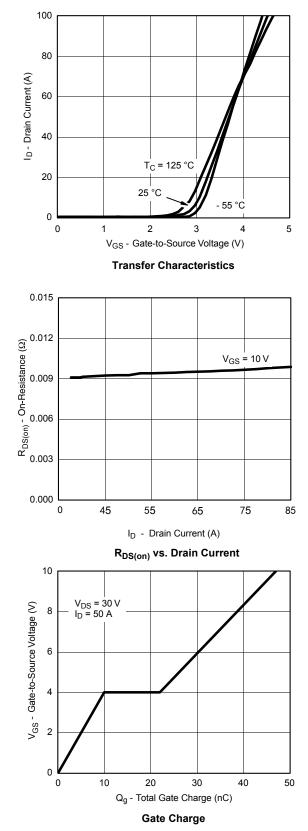
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



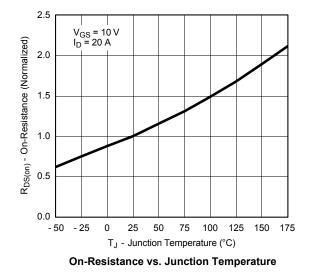


TYPICAL CHARACTERISTICS (25 °C unless noted)

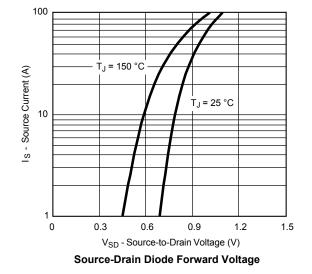


服务热线:400-655-8788



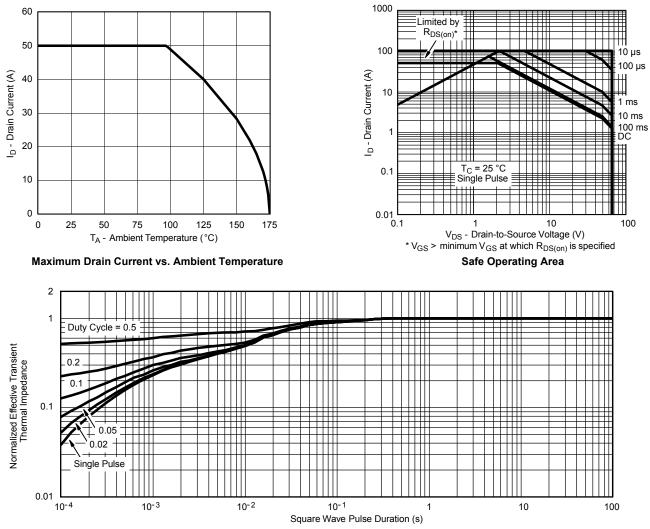


TYPICAL CHARACTERISTICS (25 °C unless noted)





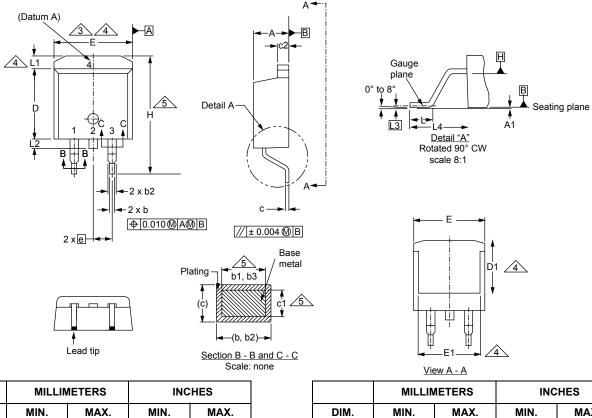
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-263AB (HIGH VOLTAGE)



	WILLINETERS		INCHES				WILLIWEIERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	DIM. MIN.	MAX.	MIN.	MAX		
А	4.06	4.83	0.160	0.190	D1	D1 6.86	-	0.270	-		
A1	0.00	0.25	0.000	0.010	E	E 9.65	10.67	0.380	0.42		
b	0.51	0.99	0.020	0.039	E1	E1 6.22	-	0.245	-		
b1	0.51	0.89	0.020	0.035	е	e 2	2.54 BSC		2.54 BSC (BSC
b2	1.14	1.78	0.045	0.070	Н	H 14.61	15.88	0.575	0.62		
b3	1.14	1.73	0.045	0.068	L	L 1.78	2.79	0.070	0.11		
С	0.38	0.74	0.015	0.029	L1	L1 -	1.65	-	0.06		
c1	0.38	0.58	0.015	0.023	L2	L2 -	1.78	-	0.07		
c2	1.14	1.65	0.045	0.065	L3	L3 0	0.25 BSC		0.010 BSC		
D	8.38	9.65	0.330	0.380	L4	L4 4.78	5.28	0.188	0.20		

Notes

- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.

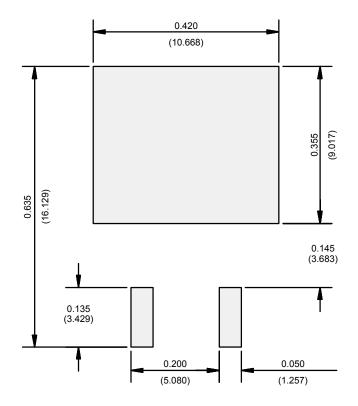
^{1.} Dimensioning and tolerancing per ASME Y14.5M-1994.

^{2.} Dimensions are shown in millimeters (inches).

^{3.} Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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